

Specification for Approval

Date: 2020/08/28

Customer : _____

TAI-TECH P/N: DCM120620F2SF-600T02-1R1-FB

CUSTOMER P/N: _____

DESCRIPTION: _____

QUANTITY: _____ pcs

| | | |
|----------------------------|--|--|
| REMARK: | | |
| | | |
| Customer Approval Feedback | | |
| | | |

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|------------------|-----------------|----------------|
| 楊祥忠 Mike Yang | 羅偉軒 Happy Lo | 何玉蓮 Anna Ho |

Wire Wound Type Common Mode Filter

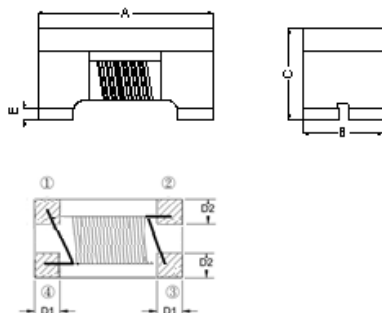
DCM120620F2SF-600T02-1R1-FB

1. Features

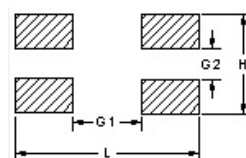
1. High common mode impedance at high frequency effects excellent noise suppression performance.
2. DCM120620F2SF series realizes small size and low profile.
3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
4. Operating temperature-40~+85°C (Including self - temperature rise)



2. Dimension



Recommended PC Board Pattern



| Series | A(mm) | B(mm) | C(mm) | D1(mm) | D2(mm) | E(mm) | L(mm) | H(mm) | G1(mm) | G2(mm) |
|------------|---------|---------|---------|----------|----------|-------------|-------|-------|--------|--------|
| 120620F2SF | 3.4±0.2 | 1.6±0.2 | 2.4 Max | 0.64±0.1 | 0.66±0.1 | 0.12 (typ.) | 3.7 | 1.7 | 2.3 | 0.5 |

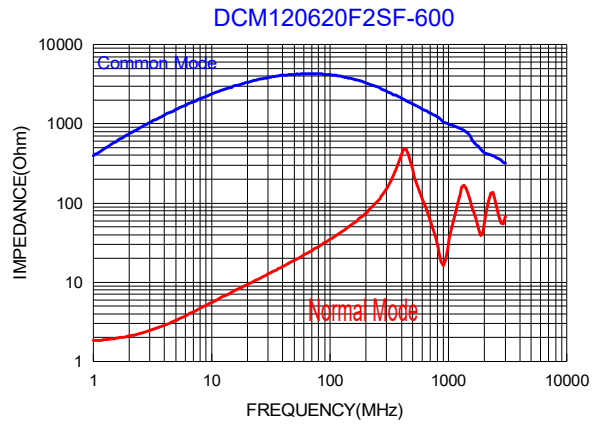
3. Part Numbering

| | | | | | | | | | | | | | |
|-----|--------|---|---|---|---|---|-----|---|----|---|-----|---|----|
| DCM | 120620 | F | 2 | S | F | - | 600 | T | 02 | - | 1R1 | - | FB |
| A | B | C | D | E | F | | G | H | I | | J | | K |

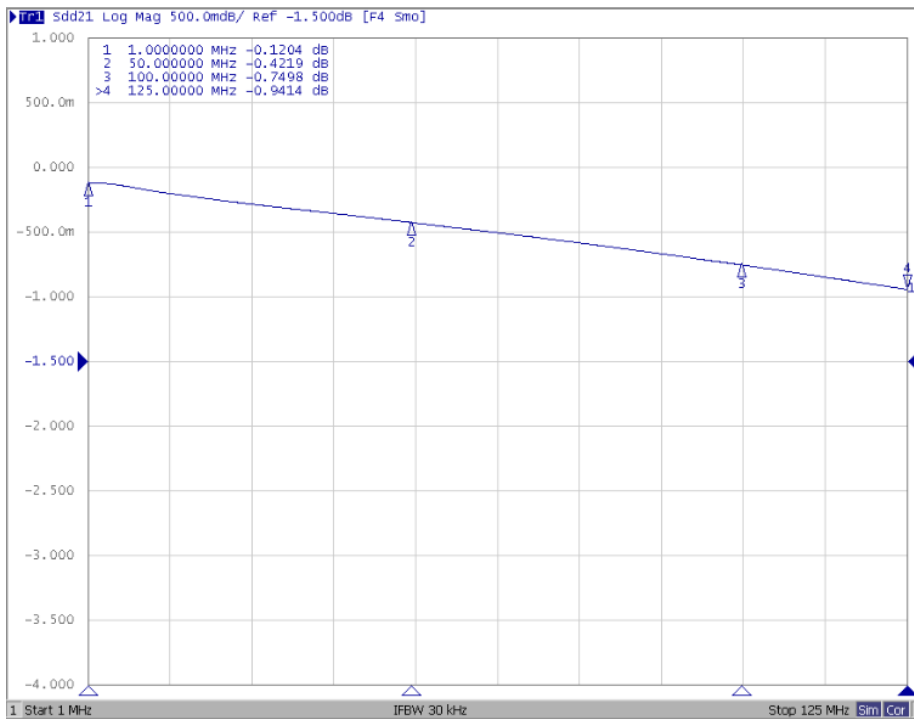
| | |
|--------------------|---------------------------|
| A: Series | |
| B: Dimension | |
| C: Material | Ferrite Core |
| D: Number of Lines | 2=2 lines |
| E: Type | S=Shielded , N=Unshielded |
| F: Lead free | |
| G: Inductance | 600=60uH |
| H: Packaging | T=Taping and Reel |
| I: Rated Current | 02=200mA |
| J: RDC | 1R1=1.1(Ω) |
| K: Control S/N | |

4. Specification

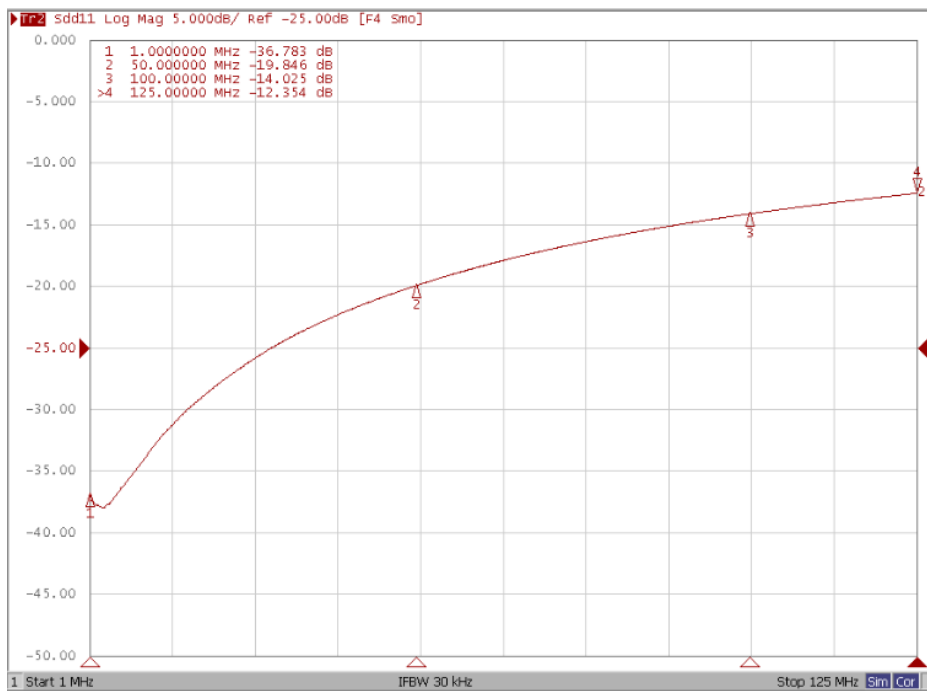
| TAI-TECH Part Number | Inductance(uH) [100kHz/0.1V] Min. | Capacitance (pF)Max | DC Resistance (Ω)Max. | Insertion loss 1~125MHz (dB) | Return loss 1~125MHz (dB) | Rated Current (mA) | Rated Volt. (Vdc) | Withstand Volt. (Vdc) max. | IR(Ω) min. |
|-----------------------------|---|------------------------|-----------------------------|------------------------------------|---------------------------------|--------------------------|-------------------------|----------------------------------|---------------|
| DCM120620F2SF-600T02-1R1-FB | 60 | 15 | 1.1 | -1.0 typ. -1.2 min. | -12 typ. -10 max. | 200 | 50 | 125 | 10M |



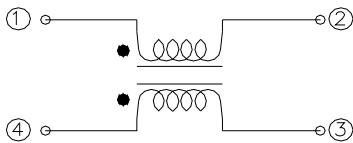
Insertion loss



Return loss

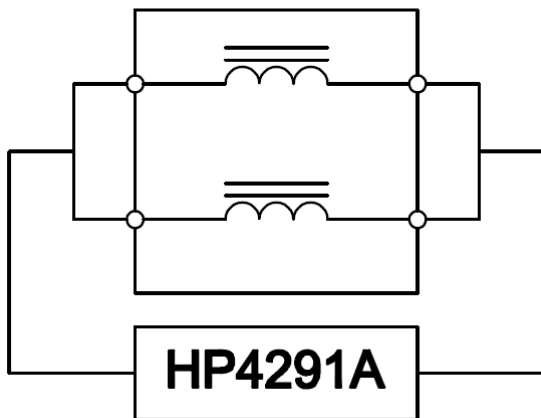


5. Schematic Diagram

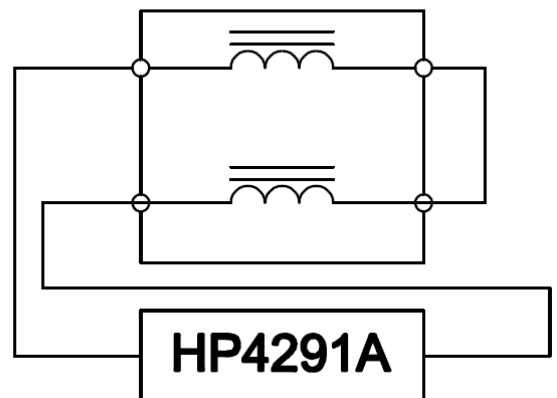


6. MEASURING CIRCUITS 2LINE

Common mode

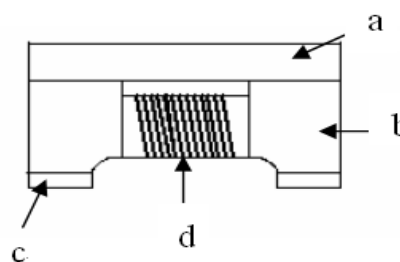


Differential mode



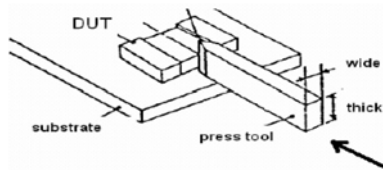
7. Materials

| No. | Description | Specification |
|-----|-------------|----------------------|
| a. | Upper Plate | Ferrite |
| b. | Core | Ferrite Core |
| c. | Termination | Ag/Ni/Sn |
| d. | Wire | Enameled Copper Wire |



8. Reliability and Test Condition

| Item | Performance | Test Condition |
|------------------------------------|---|---|
| Operating temperature | -40~+85°C (Including self - temperature rise) | |
| Storage temperature | -40~+85°C (on board) | |
| Electrical Performance Test | | |
| L(common mode) | Refer to standard electrical characteristics list. | Agilent-4291A+ Agilent -16197A |
| DCR | | Agilent-4338B |
| I.R. | | Agilent4339 |
| Temperature Rise Test | Rated Current ΔT 40°C Max | 1. Applied the allowed DC current. 2. Temperature measured by digital surface thermometer |
| Reliability Test | | |
| Life Test | Appearance : No damage. Impedance : within $\pm 15\%$ of initial value Inductance : within $\pm 10\%$ of initial value RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value | Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Temperature : 85 \pm 2°C Applied current : rated current Duration : 1000 \pm 12hrs Measured at room temperature after placing for 24 \pm 2 hrs |
| Load Humidity | | Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Humidity : 85 \pm 2% R.H, Temperature : 85 \pm 2°C Duration : 1000hrs Min. Bead : with 100% rated current Inductance: with 10% rated current Measured at room temperature after placing for 24 \pm 2 hrs |
| Moisture Resistance | | Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles 1. Baked at 50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65 \pm 2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65 \pm 2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2 hrs then keep at -10°C for 3 hrs 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs. |
| Thermal shock | | Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -40 \pm 2°C 30 \pm 5min Step2 : 25 \pm 2°C \leq 0.5min Step3 : 85 \pm 2°C 30 \pm 5min Number of cycles : 500 Measured at room temperature after placing for 24 \pm 2 hrs |
| Vibration | | Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minute Equipment : Vibration checker Total Amplitude:10g Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) |

| Item | Performance | Test Condition | | | | | | | | | | | | | | | |
|------------------------------|---|--|-----------------------|---------------------------|--|-----------------------|---------------------------|-------|----------------|----|-----------|------|------|----|----|-----------|------|
| Bending | Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value | Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec. | | | | | | | | | | | | | | | |
| Shock | Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value | <table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (V)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> <tr> <td>Lead</td> <td>50</td> <td>11</td> <td>Half-sine</td> <td>11.3</td> </tr> </tbody> </table> | Type | Peak value (g's) | Normal duration (D) (ms) | Wave form | Velocity change (V)ft/sec | SMD | 50 | 11 | Half-sine | 11.3 | Lead | 50 | 11 | Half-sine | 11.3 |
| Type | Peak value (g's) | Normal duration (D) (ms) | Wave form | Velocity change (V)ft/sec | | | | | | | | | | | | | |
| SMD | 50 | 11 | Half-sine | 11.3 | | | | | | | | | | | | | |
| Lead | 50 | 11 | Half-sine | 11.3 | | | | | | | | | | | | | |
| Solder ability | More than 95% of the terminal electrode should be covered with solder. | a. Method B, 4 hrs @155°C dry heat @235°C±5°C Testing Time :5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time :30 +0/-0.5 seconds | | | | | | | | | | | | | | | |
| Resistance to Soldering Heat | | Depth: completely cover the termination <table border="1"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table> | Temperature(°C) | Time(s) | Temperature ramp/immersion and emersion rate | Number of heat cycles | 260 ±5 (solder temp) | 10 ±1 | 25mm/s ±6 mm/s | 1 | | | | | | | |
| Temperature(°C) | Time(s) | Temperature ramp/immersion and emersion rate | Number of heat cycles | | | | | | | | | | | | | | |
| 260 ±5 (solder temp) | 10 ±1 | 25mm/s ±6 mm/s | 1 | | | | | | | | | | | | | | |
| Terminal Strength | Appearance : No damage. Impedance : within±15% of initial value Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value | Preconditioning: Run through IR reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.  | | | | | | | | | | | | | | | |

9. Soldering and Mounting

9-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

9-1.1 IR Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

9-1.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.

Fig.1 IR Soldering Reflow

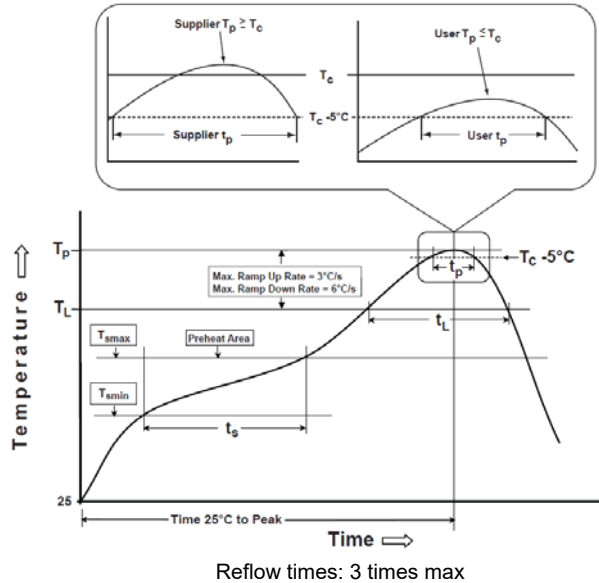


Fig.2 Iron soldering temperature profiles

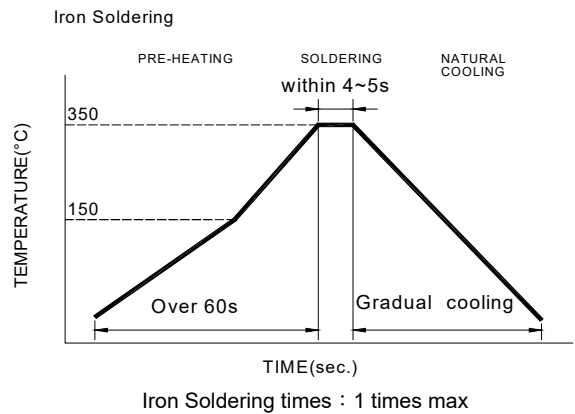


Table (1.1): Reflow Profiles

| | |
|---|------------------|
| Profile Type: | Pb-Free Assembly |
| Preheat | |
| -Temperature Min(T_{smin}) | 150°C |
| -Temperature Max(T_{smax}) | 200°C |
| -Time(t_s)from(T_{smin} to T_{smax}) | 60-120seconds |
| Ramp-up rate(T_L to T_p) | 3°C/second max. |
| Liquidus temperature(T_L) | 217°C |
| Time(t_L)maintained above T_L | 60-150 seconds |
| Classification temperature(T_c) | See Table (1.2) |
| Time(t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .) | < 30 seconds |
| Ramp-down rate(T_p to T_L) | 6°C /second max. |
| Time 25°C to peak temperature | 8 minutes max. |

T_p: maximum peak package body temperature, **T_c**: the classification temperature.
For user (customer) **T_p** should be equal to or less than **T_c**.

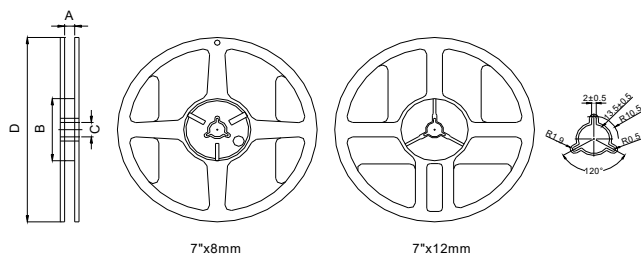
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

| | Package Thickness | Volume mm ³ <350 | Volume mm ³ 350-2000 | Volume mm ³ >2000 |
|------------------|-------------------|-----------------------------|---------------------------------|------------------------------|
| PB-Free Assembly | <1.6mm | 260°C | 260°C | 260°C |
| | 1.6-2.5mm | 260°C | 250°C | 245°C |
| | ≥2.5mm | 250°C | 245°C | 245°C |

Reflow is referred to standard IPC/JEDEC J-STD-020E ◊

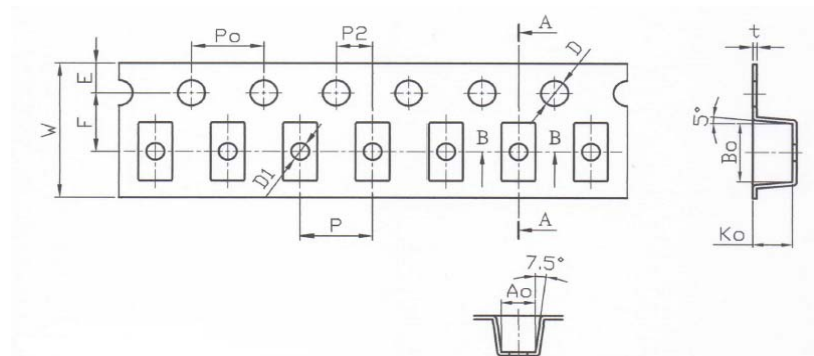
10. Packaging Information

10-1. Reel Dimension



| Type | A(mm) | B(mm) | C(mm) | D(mm) |
|--------|---------|-------|----------|-------|
| 7"x8mm | 9.0±0.5 | 60±2 | 13.5±0.5 | 178±2 |

10-2. Tape Dimension / 8mm

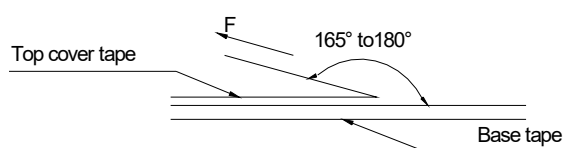


| Series | P(mm) | Po(mm) | P2(mm) | Bo(mm) | Ao(mm) | Ko(mm) | W(mm) | t(mm) | E(mm) | F(mm) | D(mm) | D1(mm) |
|--------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------------|----------|
| DCM120620F2S | 4.00±0.10 | 4.00±0.10 | 2.00±0.05 | 3.50±0.10 | 1.88±0.10 | 2.20±0.10 | 8.00±0.10 | 0.26±0.05 | 1.75±0.10 | 3.50±0.05 | 1.50+0.10/-0.00 | 1.0±0.10 |

10-3. Packaging Quantity

| Chip size | Chip/Reel | Inner Box | Middle Box | Carton |
|--------------|-----------|-----------|------------|--------|
| DCM120620F2S | 2000 | 10000 | 50000 | 100000 |

10-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

| Room Temp. (°C) | Room Humidity (%) | Room atm (hPa) | Tearing Speed mm/min |
|-----------------|-------------------|----------------|----------------------|
| 5~35 | 45~85 | 860~1060 | 300 |

Application Notice

- Storage Conditions (component level)

To maintain the solderability of terminal electrodes:

 - TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
 - Temperature and humidity conditions: Less than 40°C and 60% RH.
 - Recommended products should be used within 12 months form the time of delivery.
 - The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
 - Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
 - The use of tweezers or vacuum pick up is strongly recommended for individual components.
 - Bulk handling should ensure that abrasion and mechanical shock are minimized.

測試報告

Test Report

號碼(No.) : CE/2020/33003

日期(Date) : 2020/03/19

頁數(Page): 1 of 13

西北臺慶科技股份有限公司 / TAI-TECH ADVANCED ELECTRONICS CO., LTD.

(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO., LTD.)

(慶邦電子元器件(泗洪)有限公司 / TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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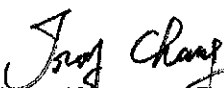
(江蘇省昆山市蓬朗昆嘉高科技工業區郭澤路 / GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

(中國, 江蘇省, 宿遷市, 泗洪縣, 經濟開發區杭州路南側, 建設北路東側 / THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P, R, CHINA)

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as):

樣品名稱(Sample Description) : WIREWOUND SERIES
樣品型號(Style/Item No.) : WCM(YCW)、WCL、HSF、HDMI、DVI、BCM、PCM、TCM、LCM、LPF、TXF、ACM、DCM(YLW)、WIH、BPH、TNH、YCM、STF、APO、TLM、SWFS、QLL SERIES
收件日期(Sample Receiving Date) : 2020/03/12
測試期間(Testing Period) : 2020/03/12 to 2020/03/19

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages).


Troy Chang / Manager - Tech
Signed for and behalf of
SGS TAIWAN LTD.
Chemical Laboratory - Taipei



PIN CODE: C6A7457C

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測試報告 Test Report

號碼(No.) : CE/2020/33003

日期(Date) : 2020/03/19

頁數(Page): 2 of 13

西北臺慶科技股份有限公司 / TAI-TECH ADVANCED ELECTRONICS CO., LTD.

(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO., LTD.)

(慶邦電子元器件(泗洪)有限公司 / TAI-PAQ ELECTRONICS (SI-HONG) CO., LTD.)

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(江蘇省昆山市蓬朗鎮嘉高科技工業區郭澤路 / GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

(中國, 江蘇省, 宿遷市, 泗洪縣, 經濟開發區杭州路南側, 建設北路東側 / THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P, R, CHINA)

測試結果(Test Results)

測試部位(PART NAME)No. 1 : 整體混測 (MIXED ALL PARTS)

| 測試項目 (Test Items) | 單位 (Unit) | 測試方法 (Method) | MDL | 結果 (Result) |
|----------------------------------|--------------|--|-------|----------------|
| | | | | No. 1 |
| 鎘 / Cadmium (Cd) | mg/kg | 參考IEC 62321-5 (2013), 以感應耦合電漿發射光譜儀檢測. / With reference to IEC 62321-5 (2013) and performed by ICP-OES. | 2 | n. d. |
| 鉛 / Lead (Pb) | mg/kg | | 2 | n. d. |
| 汞 / Mercury (Hg) | mg/kg | | 2 | n. d. |
| 六價鉻 / Hexavalent Chromium Cr(VI) | mg/kg | 參考IEC 62321-7-2 (2017), 以UV-VIS檢測. / With reference to IEC 62321-7-2 (2017) and performed by UV-VIS. | 8 | n. d. |
| 多溴聯苯總和 / Sum of PBBs | mg/kg | 參考IEC 62321-6 (2015), 以氣相層析/質譜儀檢測. / With reference to IEC 62321-6 (2015) and performed by GC/MS. | - | n. d. |
| 一溴聯苯 / Monobromobiphenyl | mg/kg | | 5 | n. d. |
| 二溴聯苯 / Dibromobiphenyl | mg/kg | | 5 | n. d. |
| 三溴聯苯 / Tribromobiphenyl | mg/kg | | 5 | n. d. |
| 四溴聯苯 / Tetrabromobiphenyl | mg/kg | | 5 | n. d. |
| 五溴聯苯 / Pentabromobiphenyl | mg/kg | | 5 | n. d. |
| 六溴聯苯 / Hexabromobiphenyl | mg/kg | | 5 | n. d. |
| 七溴聯苯 / Heptabromobiphenyl | mg/kg | | 5 | n. d. |
| 八溴聯苯 / Octabromobiphenyl | mg/kg | | 5 | n. d. |
| 九溴聯苯 / Nonabromobiphenyl | mg/kg | | 5 | n. d. |
| 十溴聯苯 / Decabromobiphenyl | mg/kg | 5 | n. d. | |

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| 測試項目 (Test Items) | 單位 (Unit) | 測試方法 (Method) | MDL | 結果 (Result) |
|--|--------------|---|-------|----------------|
| | | | | No. 1 |
| 多溴聯苯醚總和 / Sum of PBDEs | mg/kg | 參考IEC 62321-6 (2015), 以氣相層析/質譜儀檢測. / With reference to IEC 62321-6 (2015) and performed by GC/MS. | - | n. d. |
| 一溴聯苯醚 / Monobromodiphenyl ether | mg/kg | | 5 | n. d. |
| 二溴聯苯醚 / Dibromodiphenyl ether | mg/kg | | 5 | n. d. |
| 三溴聯苯醚 / Tribromodiphenyl ether | mg/kg | | 5 | n. d. |
| 四溴聯苯醚 / Tetrabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 五溴聯苯醚 / Pentabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 六溴聯苯醚 / Hexabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 七溴聯苯醚 / Heptabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 八溴聯苯醚 / Octabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 九溴聯苯醚 / Nonabromodiphenyl ether | mg/kg | | 5 | n. d. |
| 十溴聯苯醚 / Decabromodiphenyl ether | mg/kg | 5 | n. d. | |
| 鹵素 / Halogen | | | | |
| 鹵素(氟) / Halogen-Fluorine (F) (CAS No. : 14762-94-8) | mg/kg | 參考BS EN 14582 (2016), 以離子層析儀分析. / With reference to BS EN 14582 (2016). Analysis was performed by IC. | 50 | n. d. |
| 鹵素(氯) / Halogen-Chlorine (Cl) (CAS No. : 22537-15-1) | mg/kg | | 50 | n. d. |
| 鹵素(溴) / Halogen-Bromine (Br) (CAS No. : 10097-32-2) | mg/kg | | 50 | n. d. |
| 鹵素(碘) / Halogen-Iodine (I) (CAS No. : 14362-44-8) | mg/kg | | 50 | n. d. |
| 全氟辛烷磺酸 / Perfluorooctane sulfonates (PFOS-Acid, Metal Salt, Amide) | mg/kg | 參考US EPA 3550C (2007), 以液相層析/質譜儀檢測. / With reference to US EPA 3550C (2007). Analysis was performed by LC/MS. | 10 | n. d. |
| 全氟辛酸 / PFOA (CAS No. : 335-67-1) | mg/kg | | 10 | n. d. |

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| 測試項目 (Test Items) | 單位 (Unit) | 測試方法 (Method) | MDL | 結果 (Result) |
|--|--------------|---|-----|----------------|
| | | | | No. 1 |
| 鄰苯二甲酸丁苯甲酯 / BBP (Butyl Benzyl phthalate) (CAS No. : 85-68-7) | mg/kg | 參考IEC 62321-8 (2017), 以氣相層析/質譜儀檢測. / With reference to IEC 62321-8 (2017). Analysis was performed by GC/MS. | 50 | n. d. |
| 鄰苯二甲酸二丁酯 / DBP (Dibutyl phthalate) (CAS No. : 84-74-2) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二(2-乙基己基)酯 / DEHP (Di- (2-ethylhexyl) phthalate) (CAS No. : 117-81-7) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二異丁酯 / DIBP (Di-isobutyl phthalate) (CAS No. : 84-69-5) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二異癸酯 / DIDP (Di-isodecyl phthalate) (CAS No. : 26761-40-0; 68515-49-1) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二異壬酯 / DINP (Di-isononyl phthalate) (CAS No. : 28553-12-0; 68515-48-0) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二正辛酯 / DNOP (Di-n-octyl phthalate) (CAS No. : 117-84-0) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二正己酯 / DNHP (Di-n-hexyl phthalate) (CAS No. : 84-75-3) | mg/kg | | 50 | n. d. |
| 鄰苯二甲酸二戊酯 / DNPP (Di-n-pentyl phthalate) (CAS No. : 131-18-0) | mg/kg | | 50 | n. d. |
| 六溴環十二烷及所有主要被辨別出的異構物 / Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α - HBCDD, β - HBCDD, γ - HBCDD) (CAS No. : 25637-99-4 and 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8)) | mg/kg | 參考IEC 62321 (2008), 以氣相層析/質譜儀檢測. / With reference to IEC 62321 (2008). Analysis was performed by GC/MS. | 5 | n. d. |

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| 測試項目 (Test Items) | 單位 (Unit) | 測試方法 (Method) | MDL | 結果 (Result) |
|----------------------|--------------|--|-----|----------------|
| | | | | No. 1 |
| 銻 / Antimony (Sb) | mg/kg | 參考US EPA 3052 (1996), 以感應耦合電漿發射光譜儀檢測. / With reference to US EPA 3052 (1996). Analysis was performed by ICP-OES. | 2 | n. d. |
| 鈹 / Beryllium (Be) | mg/kg | 參考US EPA 3052 (1996), 以感應耦合電漿發射光譜儀檢測. / With reference to US EPA 3052 (1996). Analysis was performed by ICP-OES. | 2 | n. d. |

備註(Note) :

1. mg/kg = ppm ; 0.1wt% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n. d. = Not Detected (未檢出)
4. "-" = Not Regulated (無規格值)
5. 樣品的測試是基於申請人要求混合測試, 報告中的混合測試結果不代表其中個別單一材質的含量. (The samples was/were analyzed on behalf of the applicant as mixing sample in one testing. The above results was/were only given as the informality value.)

PFOS參考資訊(Reference Information) : 持久性有機污染物 POPs - (EU) 2019/1021

PFOS濃度在物質或製備中不得超過0.001%(10ppm), 在半成品、成品或零部件中不得超過0.1%(1000ppm), 在紡織品或塗層材料中不得超過 $1\mu\text{g}/\text{m}^2$ 。

(Outlawing PFOS as substances or preparations in concentrations above 0.001% (10ppm), in semi-finished products or articles or parts at a level above 0.1%(1000ppm), in textiles or other coated materials above $1\mu\text{g}/\text{m}^2$.)

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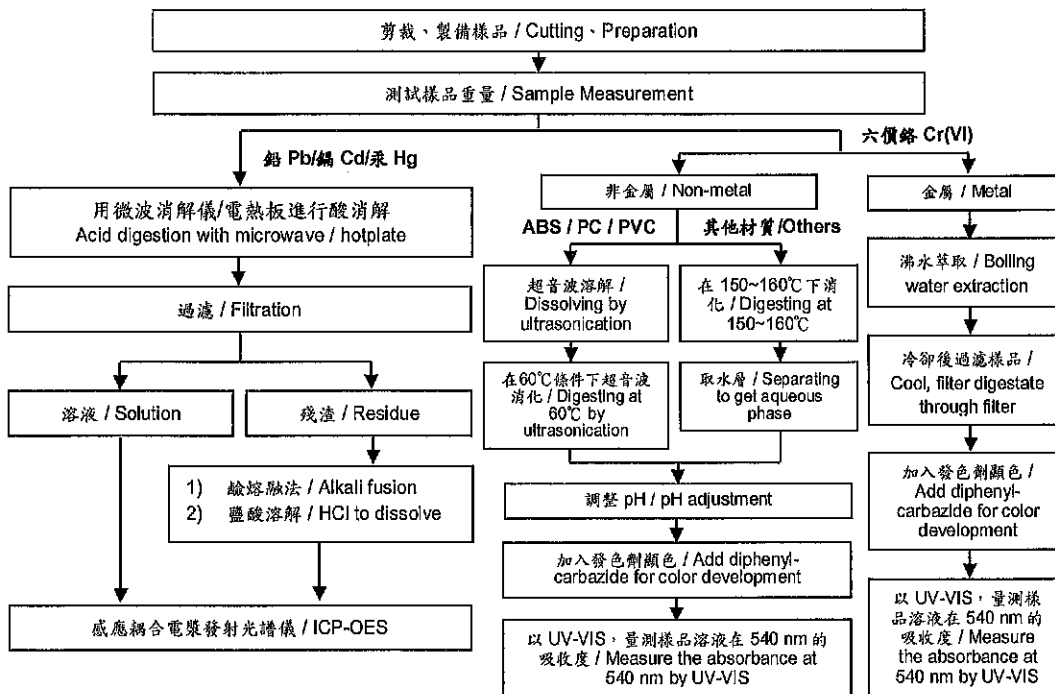
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重金屬流程圖 / Analytical flow chart of Heavy Metal

根據以下的流程圖之條件, 樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cr⁶⁺ test method excluded)



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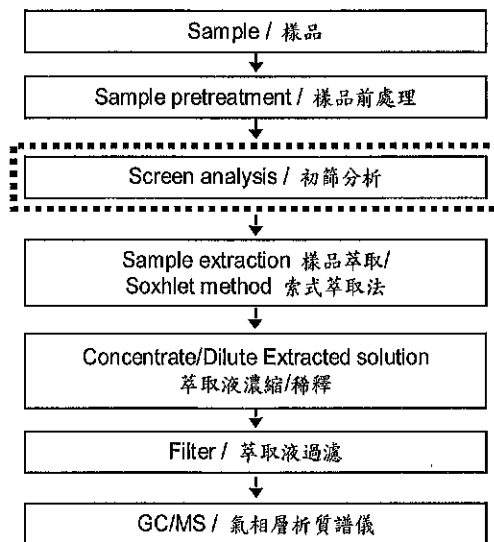
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多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBB/PBDE

初次測試程序 / First testing process —————>

選擇性篩檢程序 / Optional screen process>

確認程序 / Confirmation process - - ->



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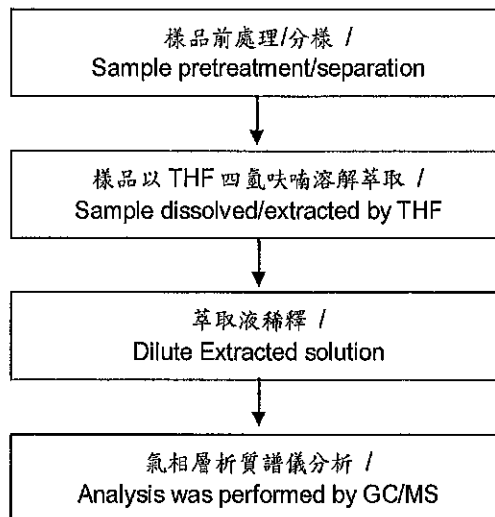
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可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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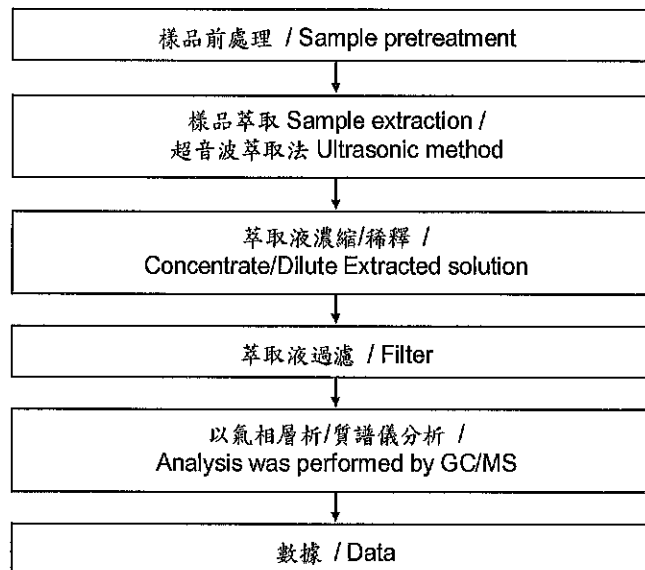
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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(臺慶精密電子(昆山)有限公司 / TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO., LTD.)

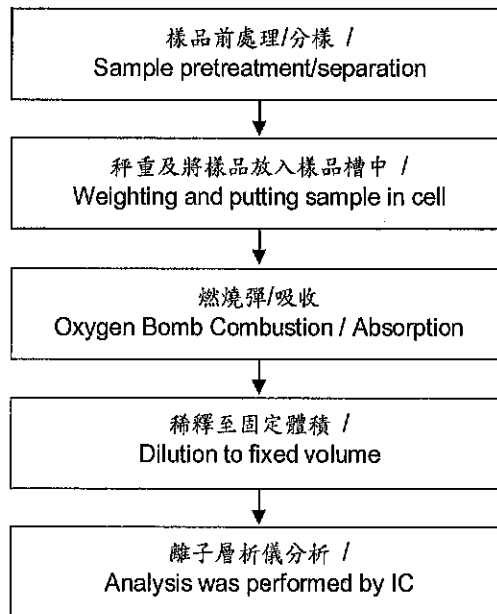
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鹵素分析流程圖 / Analytical flow chart - Halogen



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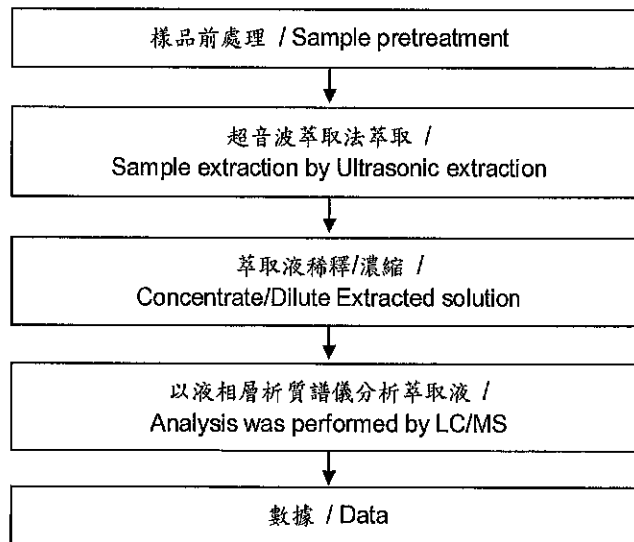
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全氟辛酸/全氟辛烷磺酸分析流程圖 / Analytical flow chart - PFOA/PFOS



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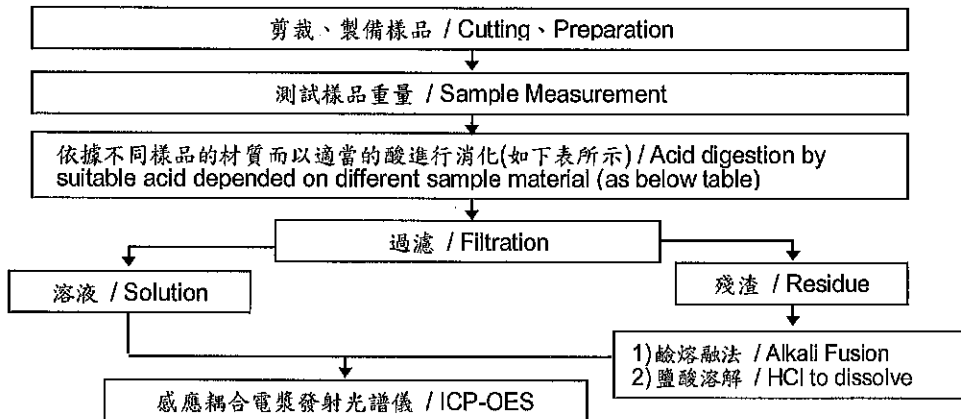
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元素以 ICP-OES 分析的消化流程圖 (Flow Chart of digestion for the elements analysis performed by ICP-OES)

根據以下的流程圖之條件, 樣品已完全溶解。 / These samples were dissolved totally by pre-conditioning method according to below flow chart.



| | |
|--|---|
| 鋼, 銅, 鋁, 焊錫 / Steel, copper, aluminum, solder | 王水, 硝酸, 鹽酸, 氫氟酸, 雙氧水 / Aqua regia, HNO ₃ , HCl, HF, H ₂ O ₂ |
| 玻璃 / Glass | 硝酸, 氫氟酸 / HNO ₃ /HF |
| 金, 鉑, 鈱, 陶瓷 / Gold, platinum, palladium, ceramic | 王水 / Aqua regia |
| 銀 / Silver | 硝酸 / HNO ₃ |
| 塑膠 / Plastic | 硫酸, 雙氧水, 硝酸, 鹽酸 / H ₂ SO ₄ , H ₂ O ₂ , HNO ₃ , HCl |
| 其他 / Others | 加入適當的試劑至完全溶解 / Added appropriate reagent to total digestion |

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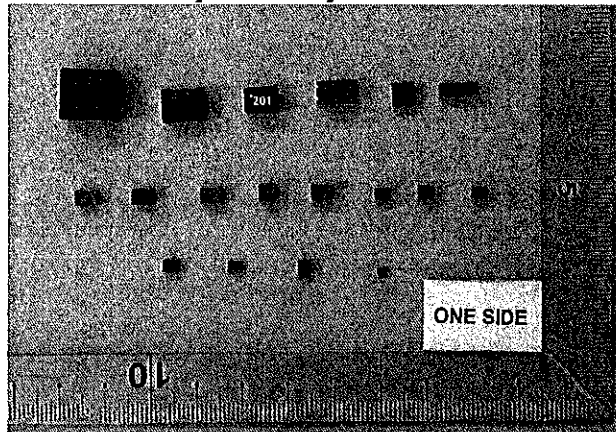
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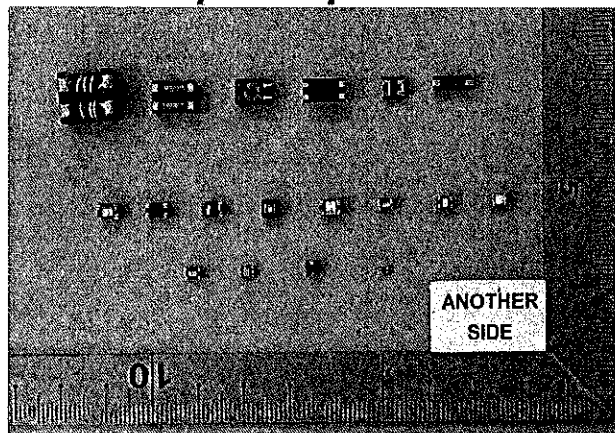
* 照片中如有箭頭標示, 則表示為實際檢測之樣品/部位. *

(The tested sample / part is marked by an arrow if it's shown on the photo.)

CE/2020/33003



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** 報告結尾 (End of Report) **

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